

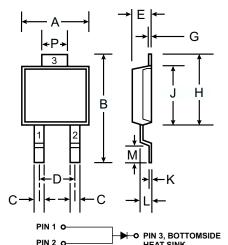
# 3A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER POWERMITE® 3

#### **Features**

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Reverse Current
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications

#### **Mechanical Data**

- Case: POWERMITE®3, Molded Plastic
- Plastic Material: UL Flammability Classification Rating 94V-0
- Moisture sensitivity: Level 1 per J-STD-020A
- Terminals: Solderable per MIL-STD-202, Method 208
- Polarity: See DiagramMarking: See Page 3
- Weight: 0.072 grams (approx.)
- Ordering Information: See Page 3



Note: Pins 1 & 2 must be electrically connected at the printed circuit board.

POWERMITE®3				
Dim	Min	Max		
Α	4.03	4.09		
В	6.40	6.61		
С	.889 NOM			
D	1.83 NOM			
E	1.10	1.14		
G	.178 NOM			
Н	5.01	5.17		
J	4.37	4.43		
K	.178 NOM			
L	.71	.77		
М	.36	.46		
Р	1.73	1.83		
All Dimensions in mm				

### **Maximum Ratings** @ T<sub>A</sub> = 25°C unless otherwise specified

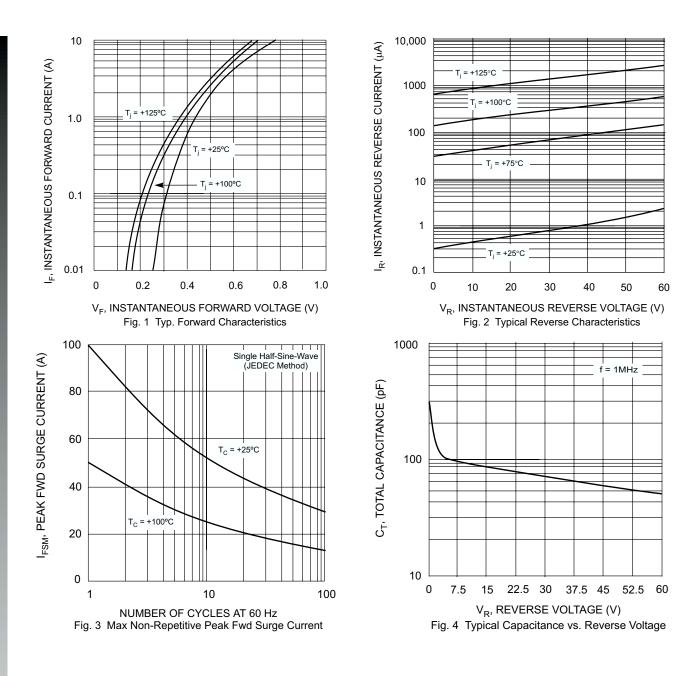
Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

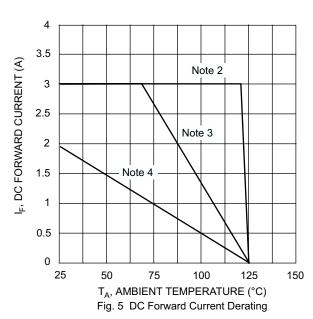
Characteristic		Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	42	V
Average Rectified Output Current (See also Figure 5)	lo	3	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load @ $T_C = 25$ (JEDEC Method) @ $T_C = 100$		100 50	А
Typical Thermal Resistance Junction to Soldering Point	$R_{ heta JS}$	3.2	°C/W
Operating Temperature Range	Tj	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

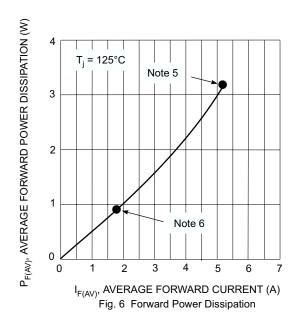
## **Electrical Characteristics** @ T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V <sub>(BR)R</sub>	60	-	_	V	I <sub>R</sub> = 0.2mA
Forward Voltage (Note 1)	V <sub>FM</sub>	_ _ _	0.59 0.53 0.72 0.63	0.63 0.57 0.76 0.67	V	$\begin{array}{ll} I_F = 3A, \ T_j = \ 25^{\circ}C \\ I_F = 3A, \ T_j = \ 125^{\circ}C \\ I_F = 6A, \ T_j = \ 25^{\circ}C \\ I_F = 6A, \ T_j = \ 125^{\circ}C \end{array}$
Reverse Current (Note 1)	I <sub>RM</sub>	_ _ _	2.0 0.6 2.5	200 20 150	μA mA mA	$\begin{array}{ll} T_j = & 25^{\circ}\text{C}, \ V_R = 60\text{V} \\ T_j = & 100^{\circ}\text{C}, \ V_R = 60\text{V} \\ T_j = & 125^{\circ}\text{C}, \ V_R = 60\text{V} \end{array}$
Total Capacitance	C <sub>T</sub>	_	130	_	pF	$f = 1.0MHz$ , $V_R = 4.0V DC$

Notes: 1. Short duration test pulse used to minimize self-heating effect.







Notes:

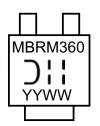
- 2.  $T_A = T_{SOLDERING\ POINT}$ ,  $R_{\theta JS} = 3.2^{\circ}C/W$ ,  $R_{\theta SA} = 0^{\circ}C/W$ .
- 3. Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0".  $R_{\theta JA}$  in range of 20-40°C/W.
- Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R<sub>θJA</sub> in range of 100-120°C/W.
- 5. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 3.
- 6. Maximum power dissipation when the device is mounted in accordance to the conditions described in Note 4.

# **Ordering Information** (Note 7)

Device	Packaging	Shipping
MBRM360-13	POWERMITE®3	5000/Tape & Reel

Notes: 7. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



MBRM360 = Product type marking code

Oll = Manufacturers' code marking

YYWW = Date code marking

YY = Last digit of year ex: 2 for 2002

WW = Week code 01 to 52